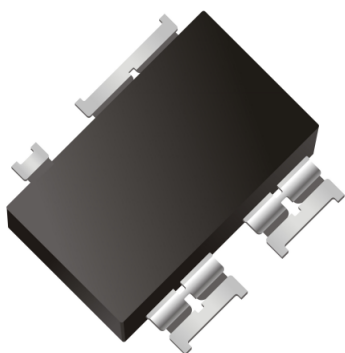


FEATURES:

- Reverse Voltage - 100 to 1000 V
- Forward Current - 8.0 A
- High Surge Current Capability
- Designed for Surface Mount Application

MECHANICAL DATA

- Case: JDBF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 2.745g / 0.0968oz

Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbols	JDBFC 08B	JDBFC 08D	JDBFC 08G	JDBFC 08J	JDBFC 08K	JDBFC 08M	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	100	200	400	600	800	1000	V
Average Rectified Output Current	I_O	8.0						A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I_{FSM}	180						A
I^2t Rating for Fusing $t=8.3ms$	I^2t	134						A ² S
Maximum Forward Voltage Per Diode at 4.0 A	V_F	1.0						V
Maximum DC Reverse Current @ $T_A=25\text{ }^{\circ}\text{C}$ at Rated DC Blocking Voltage @ $T_A=125\text{ }^{\circ}\text{C}$	I_R	5 100						μA
Typical Junction Capacitance (Note1)	C_j	45						pF
Typical Thermal Resistance (Note2)	$R_{\theta JA}$ $R_{\theta JC}$ $R_{\theta JL}$	25 5 10						$^{\circ}\text{C/W}$
Operating and Storage Temperature Range	T_j, T_{stg}	-55 ~ +150						$^{\circ}\text{C}$

Note: 1. Measured at 1MHz and applied reverse voltage of 4 V D.C.

2. Mounted on glass epoxy PC board with 4×3.81cm×3.81cm copper pad.

Fig.1 Average Rectified Output Current Derating Curve

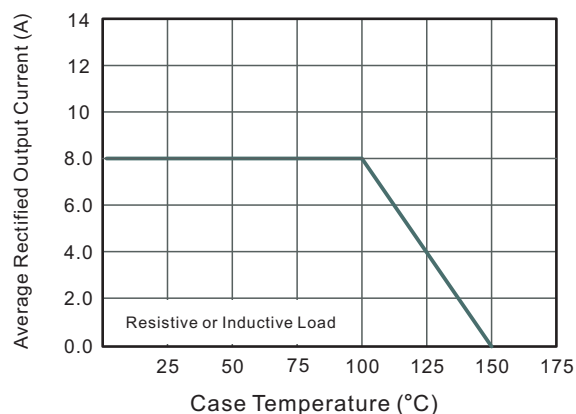


Fig.2 Typical Reverse Characteristics

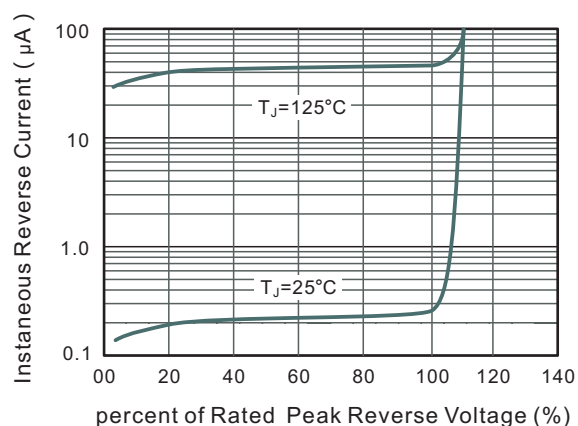


Fig.3 Typical Instaneous Forward Characteristics

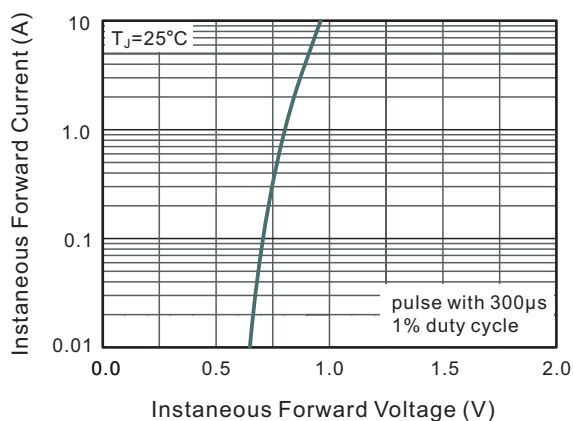


Fig.4 Typical Junction Capacitance

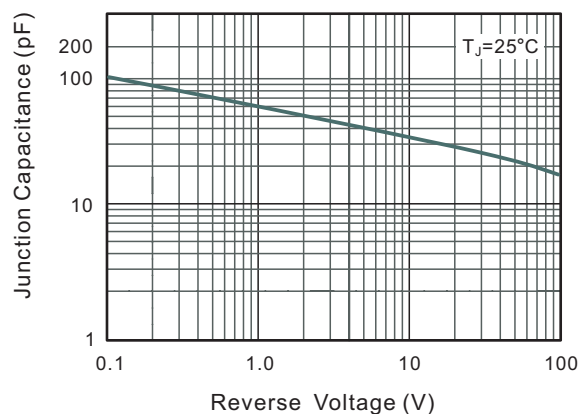
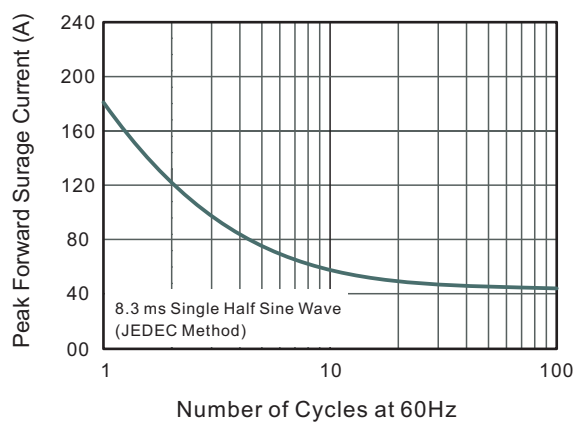
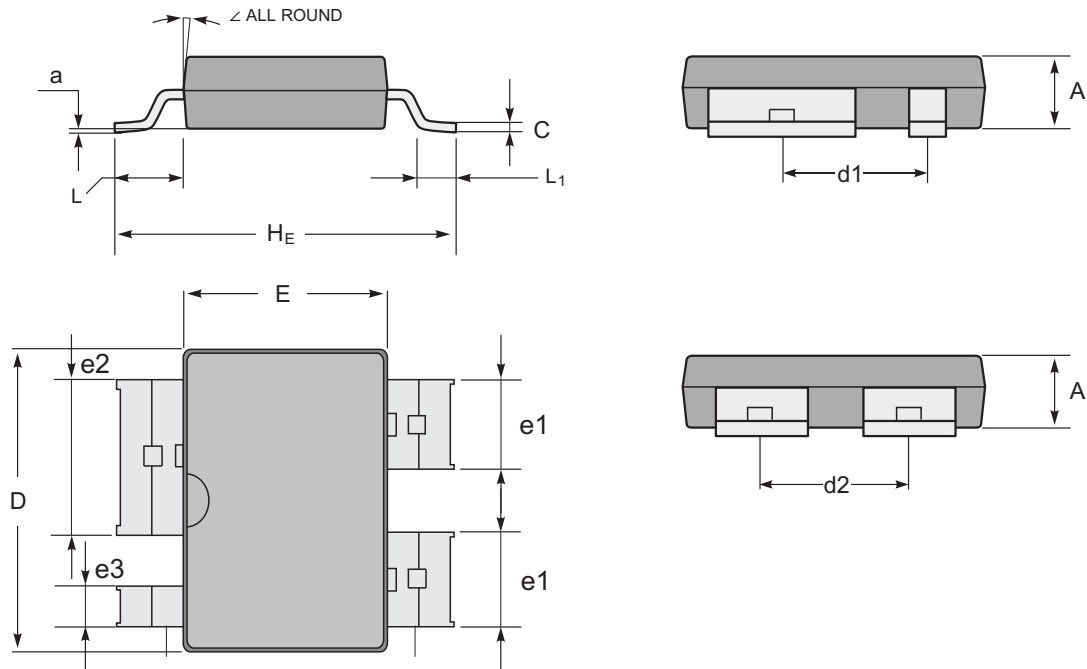


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current



PACKAGE OUTLINE

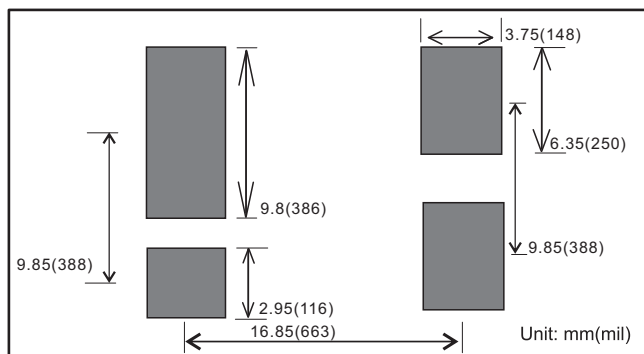
Plastic surface mounted package; 4 leads



Mechanical data

Unit		A	C	D	E	HE	e1	e2	e3	d1	d2	L	L1	a	∠
mm	max	3.9	0.50	20.9	13.6	20.5	6.35	9.8	2.95	9.85		3.85	2.72	0.19 (ref.)	12°
	nom	3.6	0.40	20.4	13.1	20.0	6.05	9.5	2.65	9.55		3.45	2.32		
	min	3.3	0.30	19.9	12.6	19.5	5.75	9.2	2.35	9.25		3.05	1.92		
mil	max	153.5	19.7	822.8	535.4	807.1	250.0	385.8	116.1	387.8		151.6	107.1	7.5 (ref.)	
	nom	141.7	15.8	803.1	515.7	787.4	238.2	374.0	104.3	376.0		135.8	91.3		
	min	129.9	11.8	783.5	496.1	767.7	226.4	362.2	92.5	364.2		120.1	75.6		

The recommended mounting pad size



Marking

Type number	Marking code
JDBFC08B	JDBFC08B
JDBFC08D	JDBFC08D
JDBFC08G	JDBFC08G
JDBFC08J	JDBFC08J
JDBFC08K	JDBFC08K
JDBFC08M	JDBFC08M